

# Aufbau RCLEDs für POF

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# Opto - Electronic Components and Applications

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**OECA**

**Company Name:** OECA Optoelectronische Komponenten und Applikations GmbH

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web site: [www.oeca.de](http://www.oeca.de)  
email: [info@oeca.de](mailto:info@oeca.de)

**Year of Foundation:** 1992

**President:** Bernd Stanitz

**Manager:** Gerhard Spickermann

**Employees:** 44

### ISO 9001 Certificate

- 19.10.1998
- 29.05.2000
- 30.05.2002

valid until May 2005



# Opto - Electronic Components and Applications

## Product lines

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OECA



Opto Electronics



Thermal Print Heads



Services

# Opto electronic devices - Overview OECA GmbH

Purchased parts (several suppliers)

## Chip

PIN  
PIN preamp  
LED  
IRED  
RC LED  
VCSEL  
Edge emitter (Laser)  
ASIC

## Submount

TO-header  
TO5, 18, 39, 46  
SOT 148  
TO 38  
PCB  
Ceramic  
Peltier cooler

## TO-device

LED, RC LED, IRED  
PIN, Avalanche FD  
PIN preamp  
VCSEL, Laser

## Fiber

diameter  $\leq 1\text{mm}$   
Multi mode  
Single mode  
Polarisation maintaining  
Polarising  
Metall coated

### Technology

- Chip mounting
- Gluing, Soldering of chips
- all types of wire bonding  
KS, TC, TS  
Al (wedge-wedge)  
Au (wedge-wedge, ball-wedge)
- Packaging  
glob topping, cap welding up to  $\phi 9\text{mm}$ ; above co-operated  
Laser welding (all contours)
- Measuring, Testing  
 $V_F, V_R, I_F, I_R, P_{opt}, P_{fiber}$

### Devices

- TO-header
- Hybrids
- Mini-DIL
- Special devices

### Technology

- hot curing glue (MM)
- cold curing glue (MM)
- UV-glue (MM)
- Laser welding (MM)
- UV-glue minimal  $9\mu\text{m}$  (SM)
- Laser welding (SM)

### Active Components

- Receptacle, Pigtail  
Single devices for MM+SM
- Combined devices  
Duplex (Multi-/Single mode)  
Cascade  
Triplex (MM)  
DIL, Butterfly-packages

### Passive Components

- Collimator
- Expanded beam connector (MM)

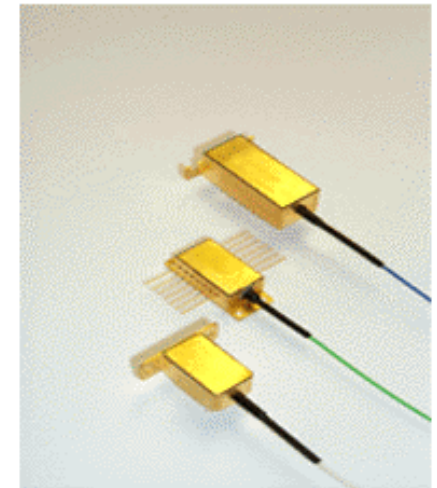
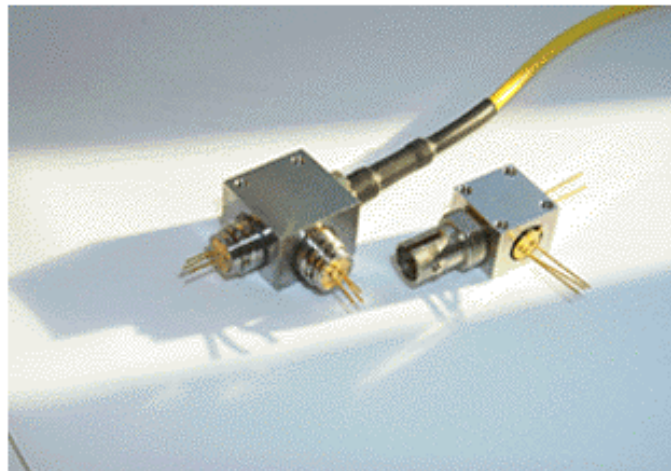
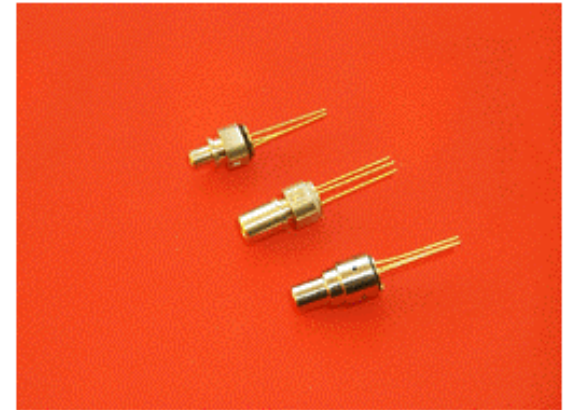
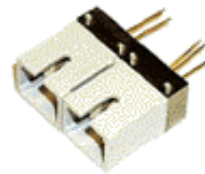
## Device assemblies

**Sleeves**

**Standard housings**

**DIL packages**

**Duplex / Cascade devices**



## **Chip assemblies**

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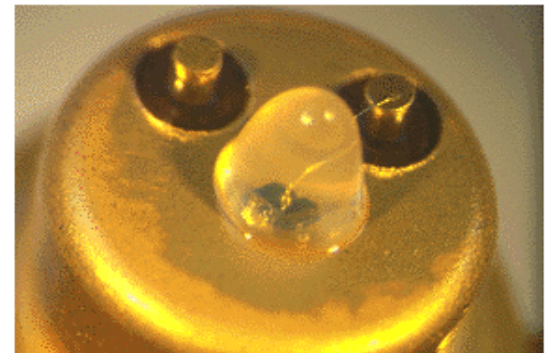
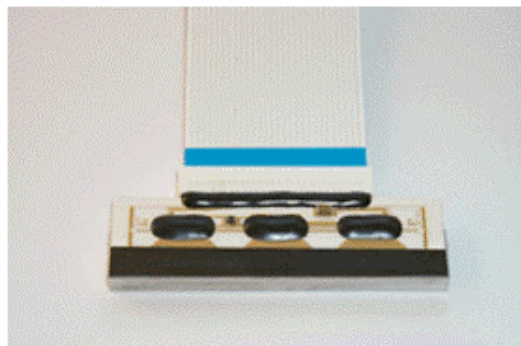
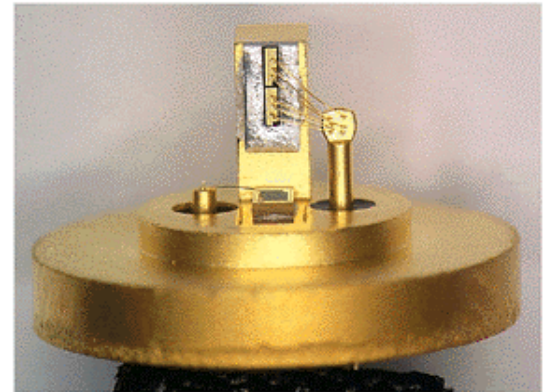
**Special header**

**Chip and wire bonding**

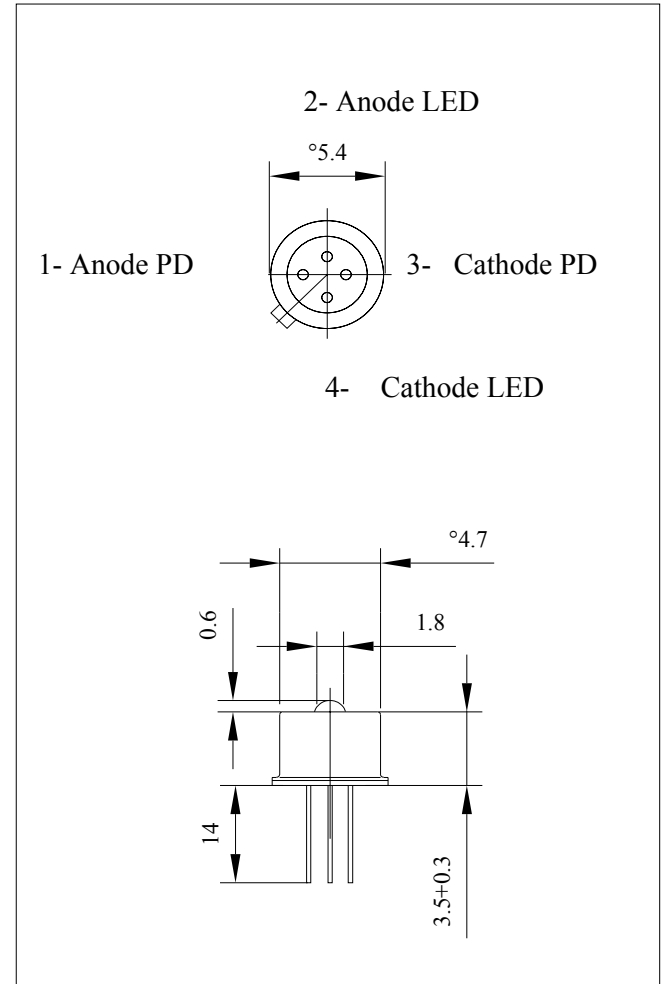
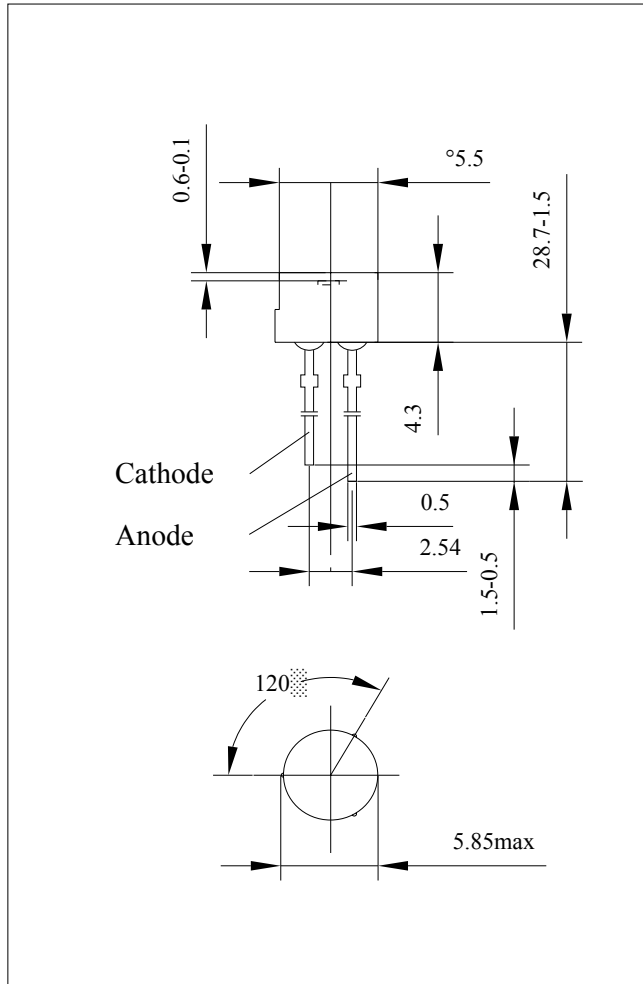
**Special optical glob topping**

**Hermetic sealing / cap welding**

**Customer specific assemblies**



# Bauformen von LEDs



# 650nm resonant cavity LED

1A46637 OECA-SMA100

650 nm High-Performance RCLED

## Description

The 1A46637 OECA-SMA100 is a 650 nm RCLED ( Resonant Cavity Light Emitting Diode ) in a SMA-Receptacle. The assembled TO-46 device is usually electrical isolated from the SMA-Receptacle ( maximum voltage 20V ) to protect the diode against ESD-damaging. The device is designed for optical communication using Plastic Optical Fiber (POF) in applications such as IEEE 1394B ( S100, S200) and 155 Mbps ATM, as well as for sensing and positioning applications.

## Absolute Maximum Ratings

(T<sub>c</sub> = 25°C ± 2°C)

Parameter	Symbol	min.	max.	Unit
Reverse Voltage	V <sub>R</sub>		5	V
Electrical Power Dissipation	P <sub>tot</sub>		130	mW
Continuous Forward Current ( f < 10 KHz )	I <sub>F</sub>		40	mA
Peak Forward Current ( duty cycle < 50%, f > 1MHz )	I <sub>FRM</sub>		85	mA
Operating Temperature	T <sub>OP</sub> = T <sub>C</sub>	-20	+70	°C
Storage Temperature	T <sub>stg</sub>	-55	+125	°C
Soldering Temperature / Soldering Time	T <sub>sold</sub> / t <sub>sold</sub>		260/5	°C/s

## Optical and Electrical Characteristics

T<sub>c</sub> = 25°C ± 2°C

Parameter	Symbol	Condition	min.	typ.	max.	Unit
Fiber Coupled Power	P <sub>fiber</sub>	Fiber: 980/1000μm, NA = 0.48 I <sub>F</sub> = 30 mA	1200			μW
Bandwidth 3 dB <sub>el</sub>	f <sub>C</sub>	I <sub>F</sub> = 30 mA	125			MHz
Peak Wavelength	λ <sub>p</sub>	I <sub>F</sub> = 30 mA	640	650	660	nm
Spectral Width ( FWHM )	Δλ	I <sub>F</sub> = 30 mA			20	nm
Forward Voltage	V <sub>F</sub>	I <sub>F</sub> = 30 mA			2.3	V